

Features

- Low voltage operation
- Low current consumption
- Miniature SMD package size
- I²C communication protocol
- Established reliability
- Capacitive technology

Applications

Industrial:

- HVAC systems
- Process monitoring
- Packaging automation
- **Medical (low/medium risk):
- Diagnostic equipment
- Analysis equipment

BPS230 Series - 2 mm Humidity Sensor

Absolute Maximum Ratings	
Supply Voltage (V _{CC})	-0.3 to 7.0
nput Voltage (V _I)	0.01.1/
CE	
SCL/SDA	
Output Voltage (VO)	0.3 to $V_{CC} + 0.3$
Hi-level Output Current (IOH)	_
1 Terminal	
All Terminals Total	20 m
ow-level Output Current (IOL)	_
1 Terminal	
All Terminals Total	
Operating Temperature (T _a)	40°C to +105°C (-40°F to +221°F
Storage Temperature (T _{stg})	50°C to +125°C (-58°F to +257°I
Recommended Operating Conditions	
Power Supply Voltage (V _{CC})	
Capacitance between V _{CC} and V _{SS} (C _p)	0.1 μF typic
Pull Up Resistor Value on SDA1 (R1)	5 kΩ typic
Pull Up Resistor Value on SCL ¹ (R2)	5 kΩ typic
Select the resistance value to meet AC characteristics.	
Electrical Characteristics	
lumidity Detection	
Measurement Range	
Resolution (10-bit)	0.1 % RH typic
Humidity Accuracy	
@ 25 °C (20 to 80 % RH)	
@ 5 °C to 45 °C (0 to 100 % RH)	
Hysteresis @ 5 °C to 45 °C (0 to 100 % RH)	±1 % RH typic
Response Time	
Reach (τ 63 % @ 25 °C, wind velocity @ 1.0 m/s)	8 second
Unless otherwise specified: V_{CC} = 1.62 to 5.5 V, V_{SS} = 0 V, T_a = -20 °C to 100 °C	
emperature Detection	
Measurement Range	30 °C to +100 °C (-22 °F to +212 °F
Resolution (11 bit)	
-10 °C to +70 °C	0.1 °C (32.18 °F
All other temperatures	0.4 °C (32.72 °F
Temperature Accuracy	
@ 5 °C to 60 °C	
@ -20 °C to 85 °C	± 1.0 °C (±33.8 °I
Reproducibility @ -30 °C to 100 °C	± 0.1 °C (±32.18 °I
Response Time	
Reach (τ 63 % (dependent on surrounding heat conduction)	30 second
Unless otherwise specified: V_{CC} = 1.62 to 5.5 V, V_{SS} = 0 V, T_{a} = -30 °C to 100 °C	
Current Consumption	
	40 - 4 + 1 400 - 4
Sleep Current (CE=0, Sleep Mode)	



WARNING Cancer and Reproductive Harm - www.P65Warnings.ca.gov

Unless otherwise specified: V_{CC} = 1.62 to 5.5 V, V_{SS} = 0 V, T_a = 0 °C to 60 °C

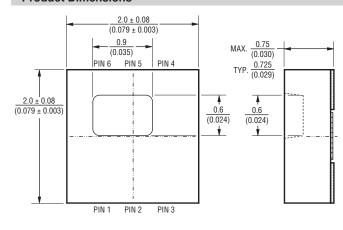
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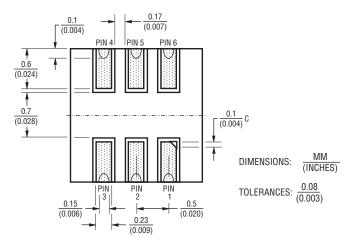
Input/Output Terminal Characteristics

Unless otherwise specified: V_{CC} = 1.62 to 5.5 V, V_{SS} = 0 V, T_a = -30 °C to 100 °C

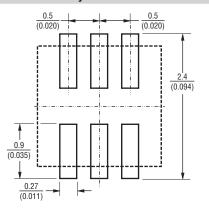
Product Characteristics

Product Dimensions





Recommended PCB Layout



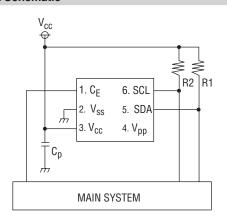
Terminal Assignment

No.	Terminal Name	Function
1	CE	Chip enable terminal
2	V_{ss}	Power supply terminal (-)
3	V_{cc}	Power supply terminal (+)
4	NC	No connection
5	SDA	I ² C serial data
6	SCL	I ² C serial clock

Specifications are subject to change without notice.

Users should verify actual device performance in their specific applications.

Basic Circuit Schematic



 $C_p \dots 0.1 \mu F$ 5k Ω R2 $5k \Omega$

NOTE: R1 and R2 are reference values. Resistor values should be selected to meet the AC characteristics.

Operation Mode

Operation	Terminal Setup	Operation State of Each Functional Block						
Mode	CE	V _{pp} Power Supply Oscillation Temp. Capacitance Detection OTI				OTP Memory	I ² C-Bus	
Sleep *1	0	NC	Stop	Stop	Stop	Stop	Stop	Stop
Standby	1	NC	Operation	Operation	Stop	Stop	Read-out Possible	Operation

^{*1} In case of power control mode, there is no sleep operation. I²C slave address (SADR) is defined as "111 1111" (7Fh).

Control Register Map

Address	Bit	Bit Name	Function	Value	ReadOut	Write-In	R/W	Init.	
	D7-1	-	Reserved	-			R	0	
00h	D0	RESET	Reset	0	Normal Operation	None	R/W	0	
				1	-	Reset Action			
	D7-6	MANMODE	Manual Detection Mode	00	Normal Ope	eration Mode	ation Mode		
	D5-3	HAVE[2:0]	Humidity Detection Value Avg.	000	No Averaging Process		R/W	0	
				001	2 Times Average Mode				
01h				01x	4 Times Average Mode				
			Mode	1xx	8 Times Av	erage Mode			
	D2 TAVE De			Temperature	0	8 Times Av	erage Mode		
		Detection Value Avg. Mode	1	16 Times Average Mode		R/W	0		

Control Register Map (Continued)

Address	Bit	Bit Name	Function	Value	ReadOut	Write-In	R/W	Init.
	D1	-	Reserved	-			R	0
01h	D0		Manual Detection	0	Standby State	Detection Operation Stop	- R/W	0
		MAN	Mode	1	Under Detection Operation	Detection Operation Start	I7/ VV	0
	D7-1	-	Reserved	=			R	0
03h	Do	EDD	Manual	0	No Error	Nothing is Done		0
	D0	ERR	Detection Error Flag	1	Error Occurred	Error Flag Reset	R/W	
04h	D7-0	HC[7:0]	Humidity Detection Result (After Correction Operation)		000h-3FFh		R	Х
	D7-2	-	Reserved	-			R	0
05h	D1-0	HC[9:8]	Humidity Detection Result (After Correction Operation)				R	х
06h	D7-0	TC[7:0]	Temperature Detection Result (After Correction Operation)		000h-7FFh		R	Х
	D7-3	-	Reserved	-			R	0
07h	D2-0	TC[10:8]	Temperature Detection Result (After Correction Operation)				R	Х
0Ah	D7-0	K[7:0]	Capacity Detection Result (Before Correction Operation)		000h-FFFFh		R	0

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Control Register Map (Continued)

Address	Bit	Bit Name	Function	Value	ReadOut	Write-In	R/W	Init.
0Bh	D7-0	K[15:8]	Capacity Detection Result (Before Correction Operation)				R	0
	D7-5	-	Reserved	-	-	-	R	0
		D4 SCR_ON_R	Standard	0	Outside Cap	acity Cutting		0
2Ch	D4		Capacity Connection Control	1	Outside Capacity Connection		R/W	
	D3-0	SCI_ ON_R[3:0]	Internal Capacity Connection Control	0h~Fh x 0.6 pF Example: At the time of 8 hours, access to internal capacity of 4.8 pF			R/W	Х
	D7-1	-	Reserved	-			R	0
03h	D0 ERR Detection		Manual	0	No Error	Nothing is Done	5	
		Detection Error Flag	1	Error Occurred	Error Flag Reset	R/W	0	

Transfer Function Formula

Humidity

RH =
$$\frac{100}{2^{10}}$$
 x RH_{IC} (0 ~ 100 % RH)

RH_{IC}: IC Humidity Output Data (10 bit)

Refer to Register Map:

 RH_{IC} = Data of the addresses 04H and 05H (000h ~ 3FFh) It changes into a decimal and is operation.

Temperature

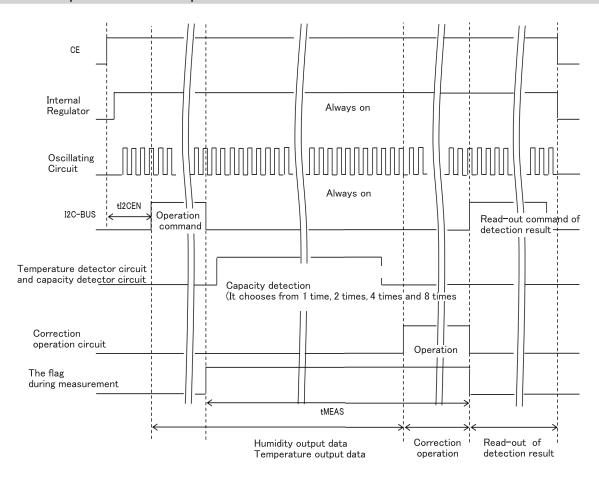
T =
$$[T_{IC} - (2^{10} - \frac{25}{0.1})] \times 0.1$$
 (-30 ~ 100 °C)

T_{IC}: IC Temperature Output Data (11 bit)

Refer to Register Map:

 T_{IC} = Data of the addresses 06H and 07H (000h ~ 7FFh) It changes into a decimal and is operation.

Capacitance/Temperature Detection Sequence

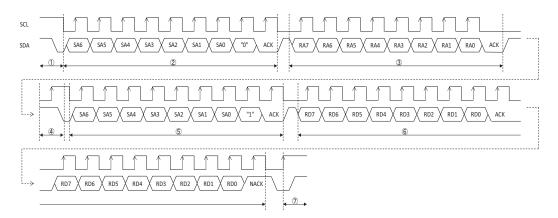


How To Order BPS230 - D 3P0 - S 10 E Model Series Humidity-Temperature Sensor Output Type D = Digital Accuracy (% RH) 3P0 = ±3.0 Moisture Sensitivity S = Standard Resolution 10 = 10-bit Packaging Designator E = 3000 pcs. per 7-inch Reel

Output Type Waveform and Data Read/Write Procedure

I²C-BUS Data Read-out Procedure

- (1) I²C master device releases START condition.
- (2) I²C master device transmits slave address and WRITE mode selection.
- (3) I²C master device transmits register address of this IC.
- (4) I²C master device releases repeated START condition. (Release method is same as START condition.)
- (5) I²C master device again transmits slave address and READ mode selection. (Read mode can be selected by transmitting "1" in 8th bit.)
- 6 I2C master device reads-out data from register address designated at 3.
 It is possible to read-out data while register address increments one, by reading-out multiple data continuously. However, during continuous read-out, please return ACK to this IC as a reply of master.
- 7) After the completion of all read-out, I²C master device releases STOP condition.



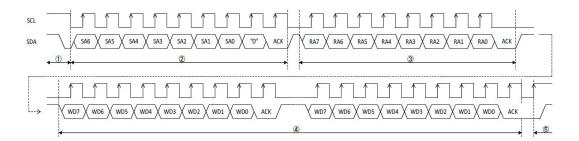
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Output Type Waveform and Data Read/Write Procedure (Continued)

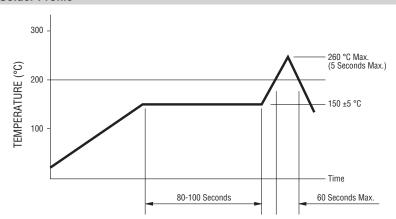
I2C-BUS Data Write-in Procedure

- (1) I²C master device releases START condition. (Start condition can be released by changing SDA from "H" to "L" while SCL is in "H" state.)
- 2 I²C master device transmits slave address and WRITE mode selection. (Write mode can be selected by transmitting "0" in 8th bit while 1~7th bits are slave address.)
- (3) I²C master device transmits register address of this IC.
- (4) I²C master device transmits write-in data.
- (5) It is possible to write-in data while register address increments one, by transmitting multiple write-in data continuously.

After the completion of transmitting all write-in data, I²C master device releases stop condition. (Stop condition can be released by changing SDA from "L" to "H" while SCL is in "H" state.)



Solder Profile

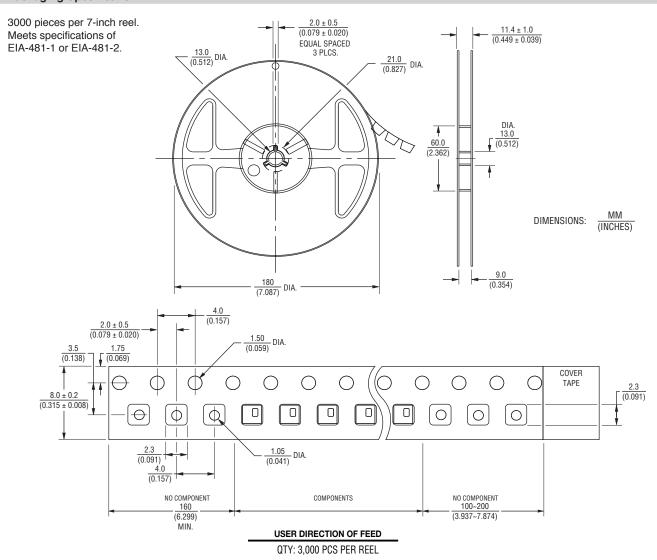


Processing Method: Reflow soldering with infrared heat or forced air convection (only once).

Notes:

- 1. No clean solder paste is recommended.
- 2. Aqueous wash is not recommended.
- Use of water soluble soldering flux should be avoided due to possible corrosion.
- 4. Multiple passes through the soldering process is not recommended.
- 5. Other SMD processes and profiles should be verified by the customer.

Packaging Specification



BOURNS®

Asia-Pacific: Tel: +886-2 2562-4117 • Email: asiacus@bourns.com

EMEA: Tel: +36 88 520 390 • Email: eurocus@bourns.com

The Americas: Tel: +1-951 781-5500 • Email: americus@bourns.com

www.bourns.com

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